

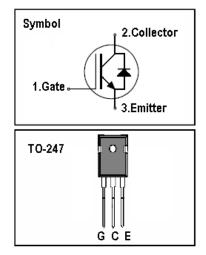
IGBT

Features

- 1200V,25A
- V_{CE(sat)(typ.)}=1.9V@V_{GE}=15V,I_C=25A
- High speed switching, up to 20kHz
- Higher system efficiency
- Soft current turn-off waveforms

General Description

JIAEN Trench FS IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.



Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
VCES	Collector-Emitter Voltage	1200 V		
V_{GES}	Gate-Emitter Voltage <u>+</u> 30			
L	Continuous Collector Current (Tc=25 °C)	50	А	
lc	Continuous Collector Current (Tc=100°C)	25	А	
Ісм	Pulsed Collector Current (Note 1)	75	А	
lF	Diode Continuous Forward Current (Tc=100 °C)	25	А	
IFM	Diode Maximum Forward Current (Note 1)	75	А	
t _{sc}	Short Circuit Withstand Time	10	us	
PD	Maximum Power Dissipation (Tc=25 °C)	300	W	
FD	Maximum Power Dissipation (Tc=100°C)	110	W	
TJ	Operating Junction Temperature Range	-55 to +150 ℃		
T _{STG}	Storage Temperature Range	-55 to +150	°C	

Thermal Characteristics

Symbol	Parameter	Max.	Units	
R _{th j-c}	Thermal Resistance, Junction to case for IGBT	0.42	°C/ W	
Rth j-c	Thermal Resistance, Junction to case for Diode	0.8	°C/ W	
Rth j-a	Thermal Resistance, Junction to Ambient	40	°C/ W	



Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV_{CES}	Collector-Emitter Breakdown Voltage	V_{GE} = 0V, I_{C} = 1mA	1200	-	-	V
I _{CES}	Collector-Emitter Leakage Current	V _{CE} = 1200V, V _{GE} = 0V	-	-	100	uA
	Gate Leakage Current, Forward	V_{GE} =30V, V_{CE} = 0V	-	-	100	nA
I _{GES}	Gate Leakage Current, Reverse	V_{GE} = -30V, V_{CE} = 0V	-	-	100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 250 \text{uA}$	4.5	-	6.5	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} =15V, I _C = 25A	-	1.9	2.4	V
Qg	Total Gate Charge	V _{cc} =600V	-	107		nC
Q _{ge}	Gate-Emitter Charge	V _{GE} =15V	-	36		nC
Q _{gc}	Gate-Collector Charge	I _C =25A	-	58		nC
t d(on)	Turn-on Delay Time		-	62	-	ns
t r	Turn-on Rise Time	$V_{CC}=600V$ $V_{GE}=15V$ $I_{C}=25A$ $R_{G}=10\Omega$ Inductive Load $T_{C}=25$ °C	-	72	-	ns
t d(off)	Turn-off Delay Time		-	460	-	ns
t f	Turn-off Fall Time		-	43	-	ns
Eon	Turn-on Switching Loss		-	2.2	-	mJ
Eoff	Turn-off Switching Loss		-	1.4	-	mJ
Ets	Total Switching Loss	-	-	3.6	-	mJ
Cies	Input Capacitance	V _{CE} =30V V _{GE} =0V	-	3000	-	pF
Coes	Output Capacitance		-	75	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	28	-	pF

Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

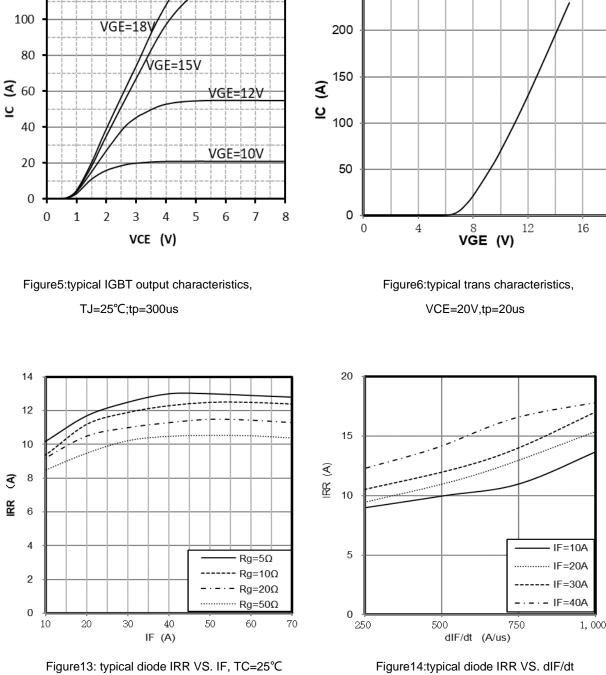
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _F	Diode Forward Voltage	I _F =25A	-	2.0	2.8	V
trr	Diode Reverse Recovery Time	V _{CE} = 600V	-	250		ns
lrr	Diode peak Reverse Recovery Current	I _F = 25A	-	10		А
Qr r	Diode Reverse Recovery Charge	dIF/dt = 200A/us	-	1350		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



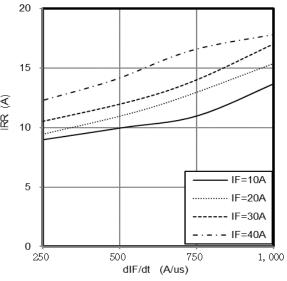
120

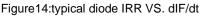


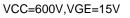
250

Typical Performance Characteristics

VCC=600V, VGE=15V

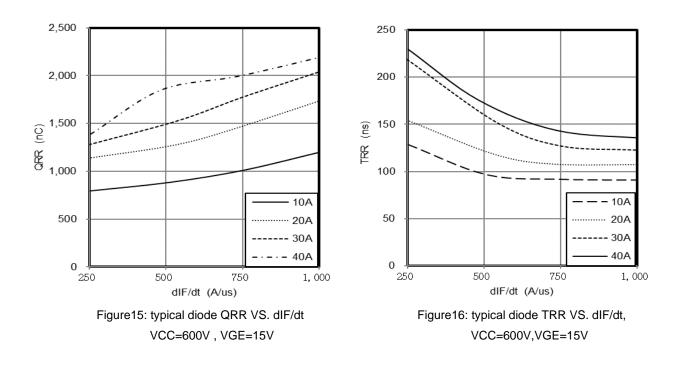


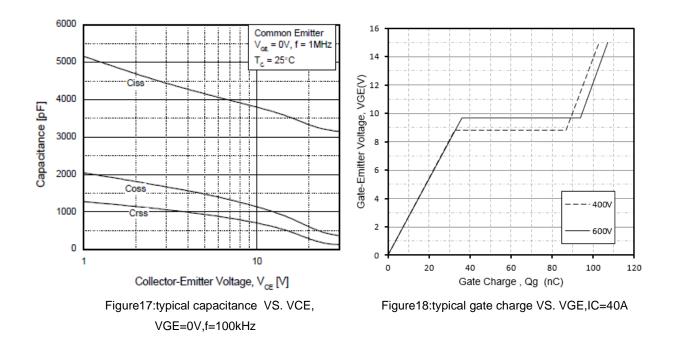






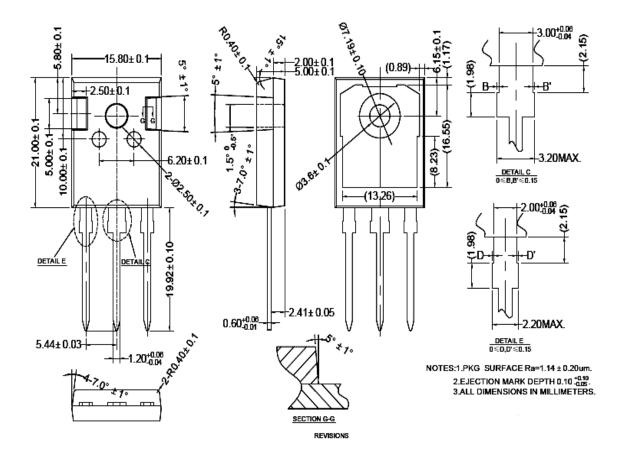
JNG25T120HFU1







TO247 PACKAGE OUTLINE



会差标注	公差值	表面粗糙度
0	±0.2	Ra3.2~6.3
0.0	±0.1	Ra1.6~3.2
0.00	±0.01	Ra0.8~1.6
0.000	±0.005	Ra0.4~0.8
0.0000	±0.002	Ra0.2~0.4

0≤D,D'≤0.15

NOTES:1.PKG SURFACE Ra=1.14 ± 0.20um. 2.EJECTION MARK DEPTH 0.10 ^{±0.06} 3.ALL DIMENSIONS IN MILLIMETERS.



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